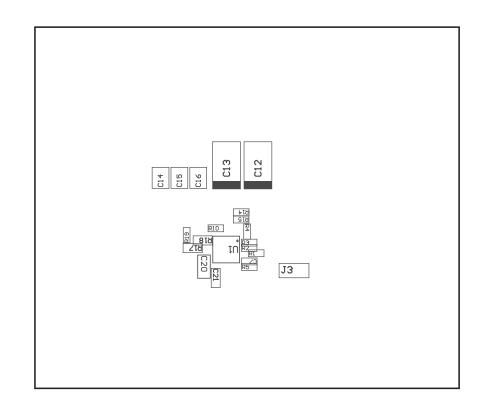


PCB VIEWED FROM TOP SIDE	BOARD #: PMP10778 REV: A SVN REV: Not In VersionCor		Not In VersionControl	
PLOT NAME = Top Assembly Drawing	GENERATED : 2/2/20	11:15:52	AM	TEXAS INSTRUMENTS



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10778 REV: A SVN REV: Not In VersionControl		t In VersionControl	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/2/20)15 11:15	5:53 AM	TEXAS INSTRUMENTS

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